

What is claimed is:

1. A photoresist applying device characterized in that:
an air-bubble collecting part is provided on a photoresist flow passage at a predetermined part of a nozzle pipe directly connected to a nozzle tip.
2. A photoresist applying device according to claim 1, wherein the nozzle pipe has an external appearance in a shape curved in an inverted U-form.
3. A photoresist applying device according to claim 1, wherein the nozzle pipe is in such a shape as continuing in a rise part, a horizontal part and a fall part.
4. A photoresist applying device according to claim 3, wherein a curved part is made at between the rise part and the fall part, the curved part having a top dead center serving as an air-bubble collecting part.
5. A photoresist applying device according to claim 3, wherein a diameter and length of the fall part of the nozzle pipe is designed to have an internal bulk of pipe capable of securing a photoresist amount greater than a photoresist amount of once projection.
6. A photoresist applying device according to claim 1, wherein the nozzle pipe is a transparent pipe.
7. A photoresist applying device according to claim 4, wherein graduations are provided on a pipe outer wall close to the top dead center.

8. A photoresist applying device according to claim 7, wherein a staying amount of air bubble requiring air-bubble removal is previously defined and a size of air bubble is measured by the graduations as required.

9. A photoresist applying device according to claim 4, wherein the curved part of the nozzle pipe is fixed and supported by a jig.